



Vincotech

# B0-SP10S3A100S710-LR69L03T

datasheet

*flow*BOOST S3 symmetric triple

950 V / 100 A

## Features

- Triple Symmetric Booster
- Latest IGBT & SiC technology
- Low inductance housing
- Integrated NTC

## Target applications

- Solar Inverters

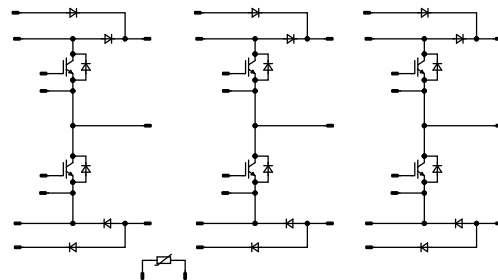
## Types

- B0-SP10S3A100S710-LR69L03T

## *flow* S3 12 mm housing



## Schematic





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## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>Boost Switch</b>				
Collector-emitter voltage	$V_{CES}$		950	V
Collector current (DC current)	$I_C$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	77	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	200	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	145	W
Gate-emitter voltage	$V_{GES}$		$\pm 20$	V
Maximum junction temperature	$T_{jmax}$		175	°C
<b>Boost Diode</b>				
Peak repetitive reverse voltage	$V_{RRM}$		1200	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	55	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	188	A
Surge (non-repetitive) forward current	$I_{FSM}$	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 25\text{ °C}$	284	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	152	W
Maximum junction temperature	$T_{jmax}$		175	°C
<b>Boost Sw. Protection Diode</b>				
Peak repetitive reverse voltage	$V_{RRM}$		1600	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	64	A
Surge (non-repetitive) forward current	$I_{FSM}$	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	400	A
Surge current capability	$I^2t$		800	A²s
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	77	W
Maximum junction temperature	$T_{jmax}$		150	°C



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## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>ByPass Diode</b>				
Peak repetitive reverse voltage	$V_{RRM}$		1600	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	64	A
Surge (non-repetitive) forward current	$I_{FSM}$	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	400	A
Surge current capability	$I^2t$		800	A <sup>2</sup> s
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	77	W
Maximum junction temperature	$T_{jmax}$		150	°C

## Module Properties

### Thermal Properties

Storage temperature	$T_{stg}$		-40...+125	°C
Operation temperature under switching condition	$T_{jop}$		-40...+( $T_{jmax} - 25$ )	°C

### Isolation Properties

Isolation voltage	$V_{isol}$	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
Creepage distance			8,83	mm
Clearance			7,54	mm
Comparative Tracking Index	CTI		≥ 600	

\*100 % tested in production



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## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max		

### Boost Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,00167	25	4,35	5,1	5,85	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		100	25 125 150		1,67 1,94 2,01	2,35 <sup>(1)</sup>	V
Collector-emitter cut-off current	$I_{CES}$		0	950		25			2	μA
Gate-emitter leakage current	$I_{GES}$		20	0		25			100	nA
Internal gate resistance	$r_g$							1,5		Ω
Input capacitance	$C_{ies}$	$f = 100 \text{ kHz}$	0	25		25		6500		pF
Output capacitance	$C_{oes}$							139		pF
Reverse transfer capacitance	$C_{res}$							20		pF
Gate charge	$Q_g$		15		0	25		230		nC

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 4,4 \text{ W/mK}$ (PTM)						0,66		K/W
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#### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 4 \text{ Ω}$ $R_{goff} = 4 \text{ Ω}$	0/15	600	65	25 125 150		36,16 34,88 34,56		ns
Rise time	$t_r$					25 125 150		11,2 12,16 12,16		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		185,6 228,8 243,52		ns
Fall time	$t_f$					25 125 150		24,78 59,43 73,97		ns
Turn-on energy (per pulse)	$E_{on}$	$Q_{tFWD}=0,133 \text{ μC}$ $Q_{tFWD}=0,155 \text{ μC}$ $Q_{tFWD}=0,159 \text{ μC}$				25 125 150		1,28 1,46 1,48		mWs
Turn-off energy (per pulse)	$E_{off}$					25 125 150		1,89 3,16 3,37		mWs



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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Boost Diode

#### Static

Forward voltage	$V_F$				40	25 125 150		1,51 2,03 2,13	1,8 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_i = 1200$ V				25		120	1000	µA

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						0,62		K/W
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#### Dynamic

Peak recovery current	$I_{RRM}$	$di/dt=4635$ A/µs $di/dt=4437$ A/µs $di/dt=4492$ A/µs	0/15	600	65	25 125 150		28,6 30,38 30,41		A
Reverse recovery time	$t_{rr}$					25 125 150		15,25 16,18 16,52		ns
Recovered charge	$Q_r$					25 125 150		0,133 0,155 0,159		µC
Reverse recovered energy	$E_{rec}$					25 125 150		0,047 0,057 0,058		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		5333 5331 5091		A/µs



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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]		Min	Typ	Max	

### Boost Sw. Protection Diode

#### Static

Forward voltage	$V_F$				35	25 125 150		1,09 1,02 1,02	1,5 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_r = 1600$ V				25 150			100 2000	μA

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						0,91		K/W
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### ByPass Diode

#### Static

Forward voltage	$V_F$				35	25 125 150		1,09 1,02 1,02	1,5 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_r = 1600$ V				25 150			100 2000	μA

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						0,91		K/W
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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Thermistor

#### Static

Rated resistance	$R$					25		22		kΩ
Deviation of $R_{100}$	$\Delta_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	$P$							5		mW
Power dissipation constant	$d$					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 1 \%$						3962		K
B-value	$B_{(25/100)}$	Tol. $\pm 1 \%$						4000		K
Vincotech Thermistor Reference									I	

<sup>(1)</sup> Value at chip level

<sup>(2)</sup> Only valid with pre-applied Vincotech thermal interface material.



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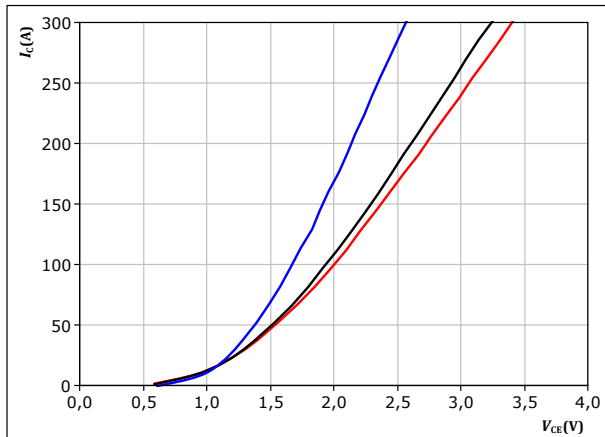
datasheet

## Boost Switch Characteristics

figure 1. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

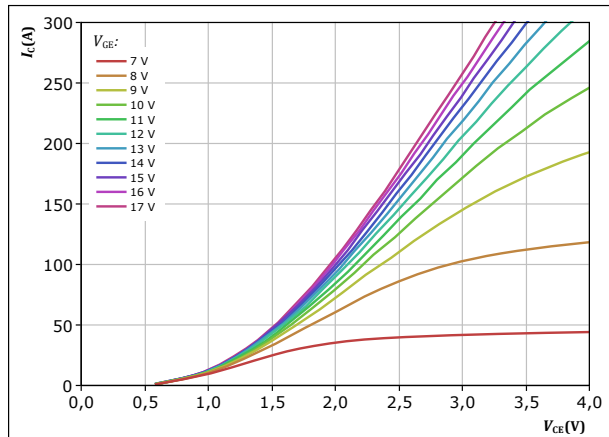


$t_p = 250 \mu s$   
 $V_{GE} = 15 V$   
 $T_j:$  25 °C, 125 °C, 150 °C

figure 2. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

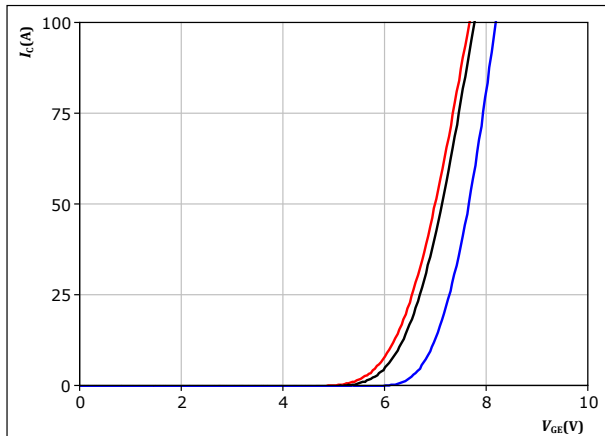


$t_p = 250 \mu s$   
 $T_j = 150 ^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

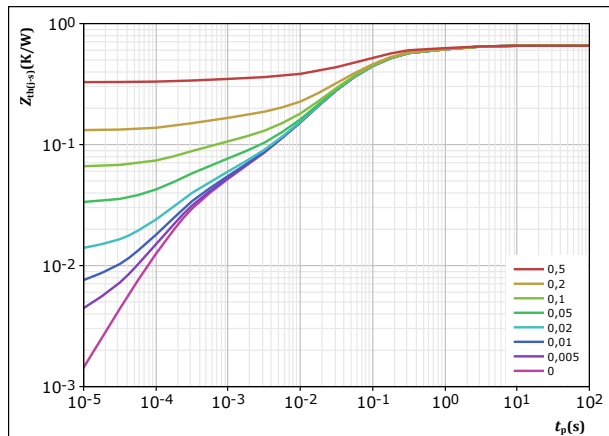


$t_p = 250 \mu s$   
 $V_{CE} = 10 V$   
 $T_j:$  25 °C, 125 °C, 150 °C

figure 4. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 0,656 K/W$   
IGBT thermal model values  

$R$ (K/W)	$\tau$ (s)
8,75E-02	1,42E+00
3,39E-01	1,02E-01
1,74E-01	2,16E-02
2,53E-02	1,80E-03
3,08E-02	2,55E-04





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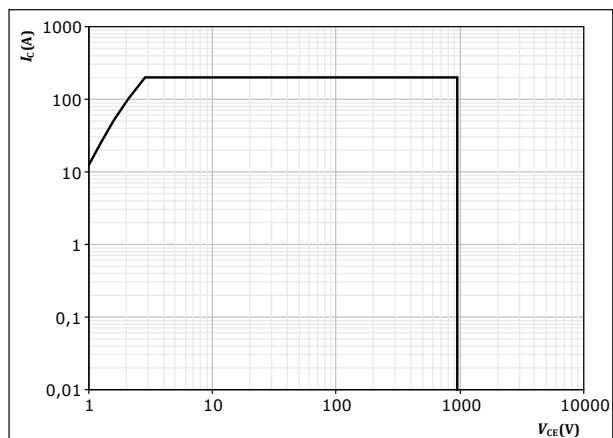
## Boost Switch Characteristics

figure 5.

IGBT

Safe operating area

$I_C = f(V_{CE})$



$D = \text{single pulse}$

$T_s = 80 \text{ } ^\circ\text{C}$   
 $V_{GE} = 15 \text{ V}$   
 $T_j = T_{jmax}$



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## Boost Diode Characteristics

figure 6. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

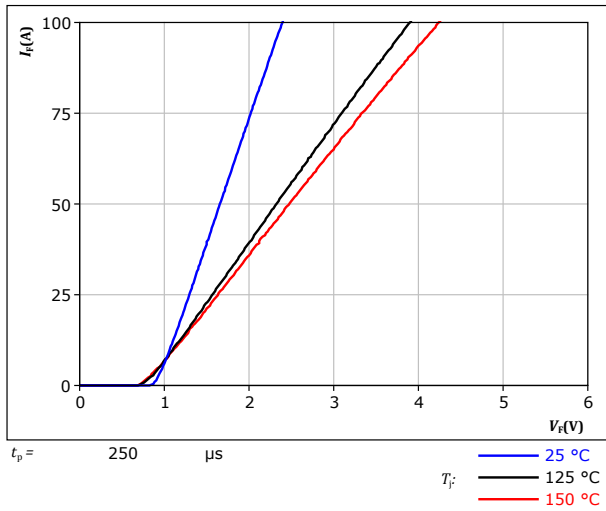
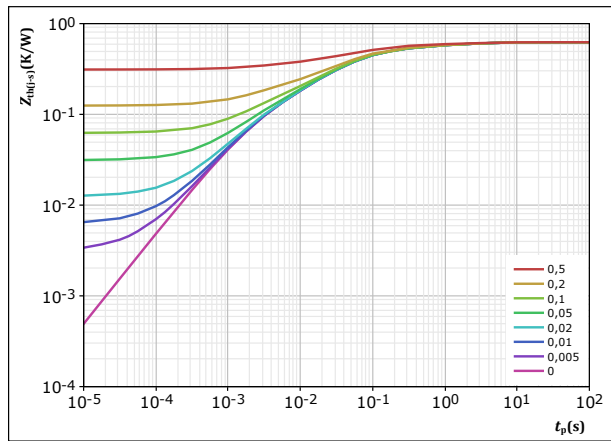


figure 7. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	$t_p / T$	
$R_{th(j-s)} =$	0,624	K/W
FWD thermal model values		
$R$ (K/W)	$\tau$ (s)	
4,85E-02	3,13E+00	
8,72E-02	4,67E-01	
2,96E-01	6,09E-02	
1,32E-01	1,18E-02	
6,05E-02	1,84E-03	



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## Boost Sw. Protection Diode Characteristics

figure 8. Rectifier

Typical forward characteristics

$$I_F = f(V_F)$$

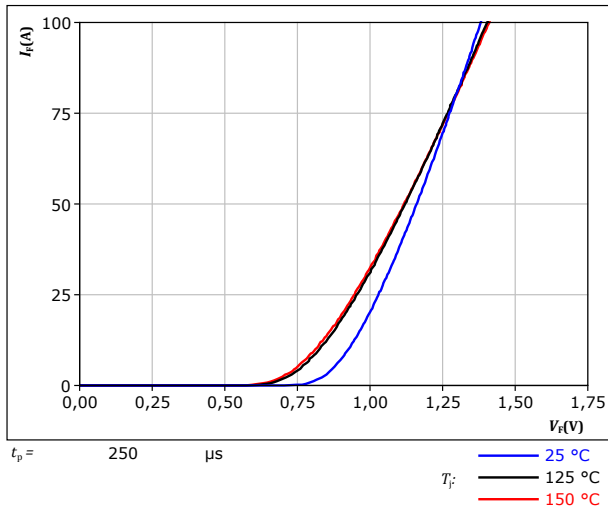
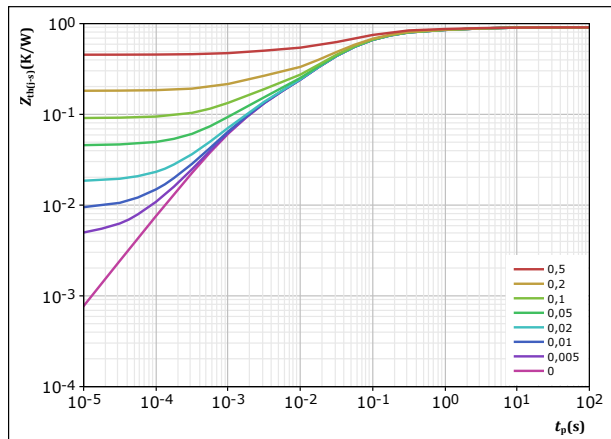


figure 9. Rectifier

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$





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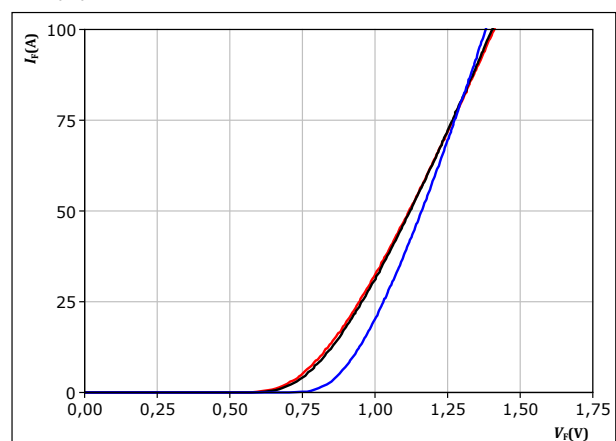
## ByPass Diode Characteristics

figure 10.

Rectifier

Typical forward characteristics

$$I_F = f(V_F)$$



$t_p = 250 \mu s$

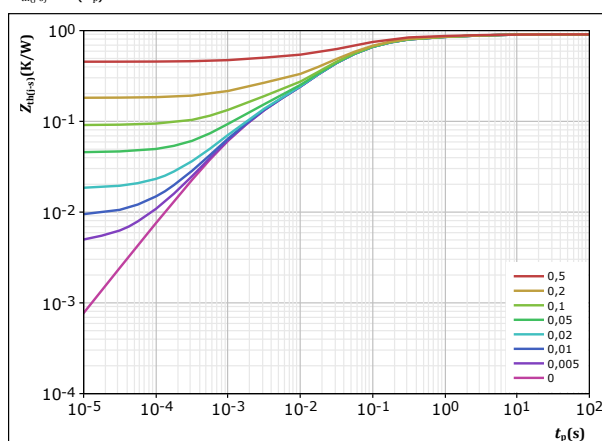
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 11.

Rectifier

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	$t_p / T$
$R_{th(j-s)} =$	0,908 K/W
Rectifier thermal model values	
$R$ (K/W)	$\tau$ (s)
4,71E-02	4,22E+00
8,03E-02	6,88E-01
3,52E-01	9,74E-02
3,38E-01	2,41E-02
9,09E-02	1,52E-03



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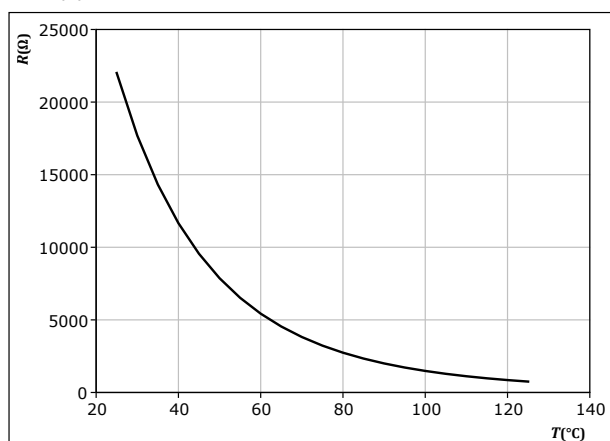
## Thermistor Characteristics

figure 12.

Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$





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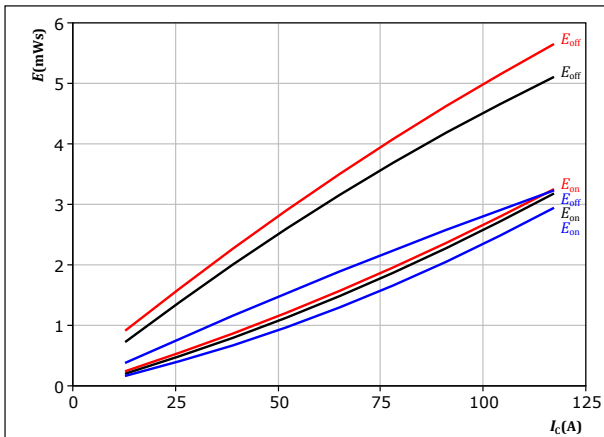
## Boost Switching Characteristics

figure 13.

IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_C)$$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = 0/15$  V  
 $R_{gon} = 4$   $\Omega$   
 $R_{goff} = 4$   $\Omega$

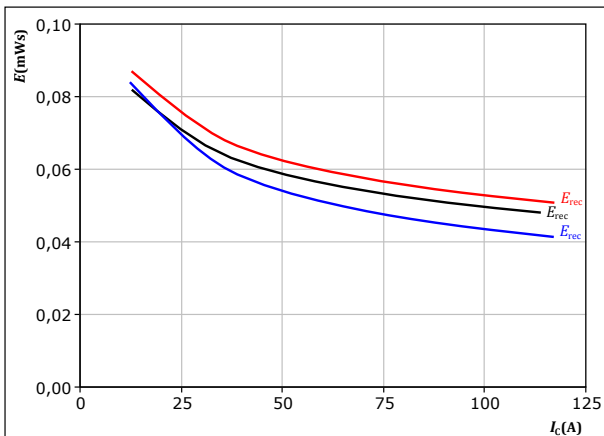
$T_j$ : 25 °C  
125 °C  
150 °C

figure 15.

FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_C)$$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = 0/15$  V  
 $R_{gon} = 4$   $\Omega$

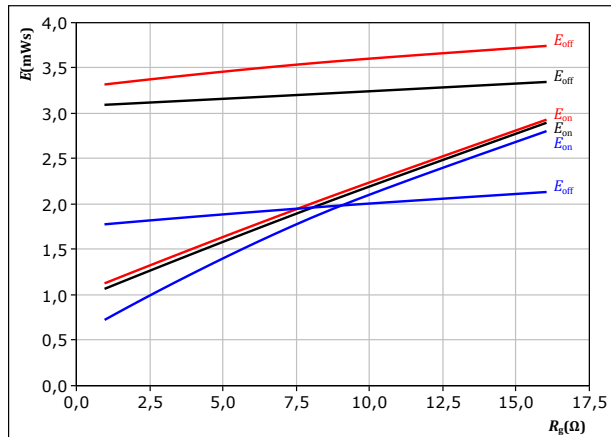
$T_j$ : 25 °C  
125 °C  
150 °C

figure 14.

IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = 0/15$  V  
 $I_C = 65$  A

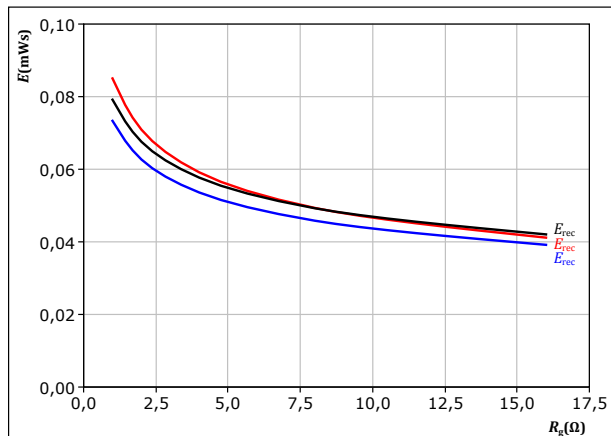
$T_j$ : 25 °C  
125 °C  
150 °C

figure 16.

FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = 0/15$  V  
 $I_C = 65$  A

$T_j$ : 25 °C  
125 °C  
150 °C



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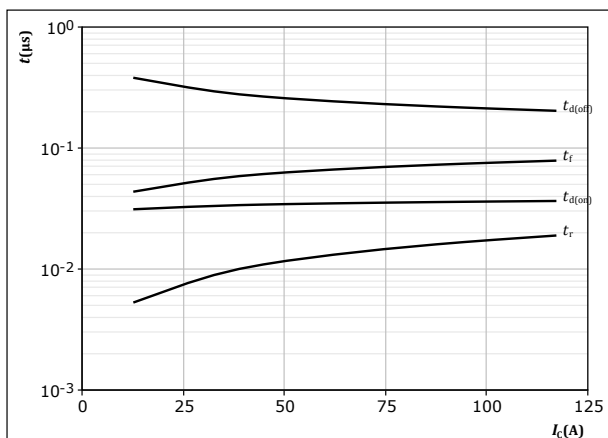
## Boost Switching Characteristics

figure 17.

IGBT

Typical switching times as a function of collector current

$$t = f(I_c)$$



With an inductive load at

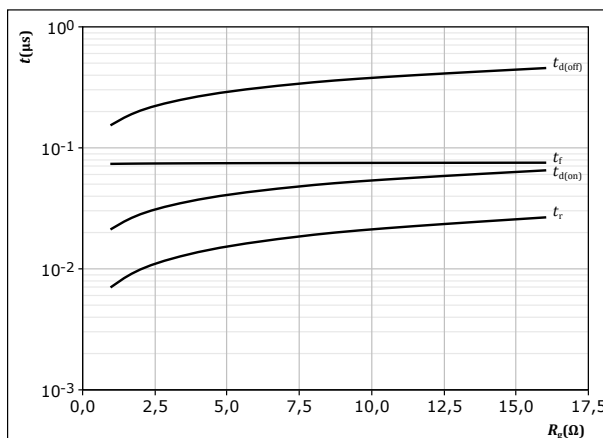
$T_j = 150 \text{ } ^\circ\text{C}$   
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = 0/15 \text{ V}$   
 $R_{gon} = 4 \text{ } \Omega$   
 $R_{goff} = 4 \text{ } \Omega$

figure 18.

IGBT

Typical switching times as a function of gate resistor

$$t = f(R_g)$$



With an inductive load at

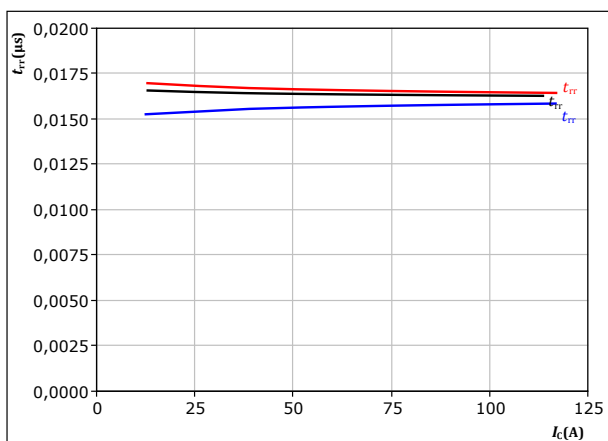
$T_j = 150 \text{ } ^\circ\text{C}$   
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = 0/15 \text{ V}$   
 $I_c = 65 \text{ A}$

figure 19.

FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_c)$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = 0/15 \text{ V}$   
 $R_{gon} = 4 \text{ } \Omega$

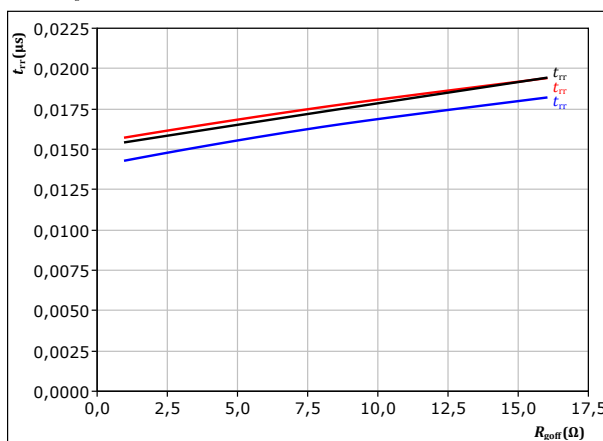
$T_j$ : 25 °C (blue)  
 125 °C (black)  
 150 °C (red)

figure 20.

FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor

$$t_{rr} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = 0/15 \text{ V}$   
 $I_c = 65 \text{ A}$

$T_j$ : 25 °C (blue)  
 125 °C (black)  
 150 °C (red)



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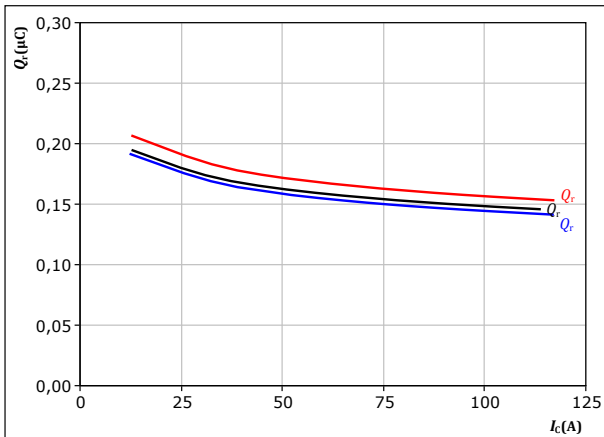
## Boost Switching Characteristics

figure 21.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = 0/15 \text{ V}$   
 $R_{gon} = 4 \text{ } \Omega$

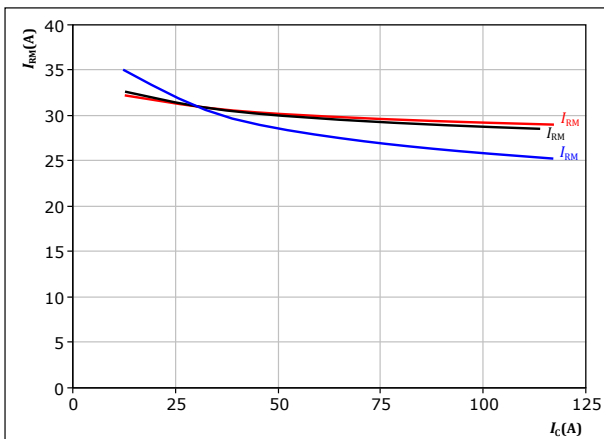
$T_j$ : 25 °C  
125 °C  
150 °C

figure 23.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = 0/15 \text{ V}$   
 $R_{gon} = 4 \text{ } \Omega$

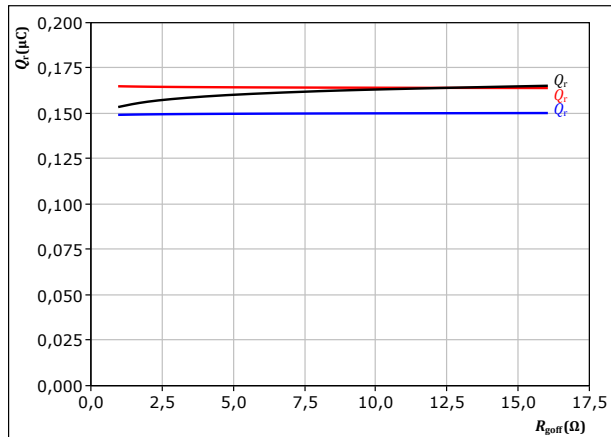
$T_j$ : 25 °C  
125 °C  
150 °C

figure 22.

FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = 0/15 \text{ V}$   
 $I_c = 65 \text{ A}$

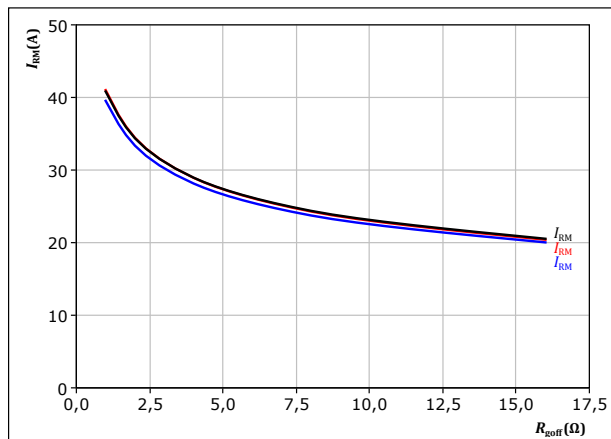
$T_j$ : 25 °C  
125 °C  
150 °C

figure 24.

FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = 0/15 \text{ V}$   
 $I_c = 65 \text{ A}$

$T_j$ : 25 °C  
125 °C  
150 °C





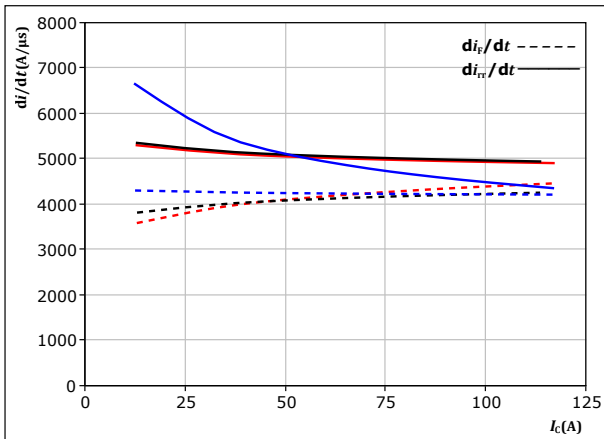
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datasheet

## Boost Switching Characteristics

**figure 25.** FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_f/dt, di_r/dt = f(I_C)$



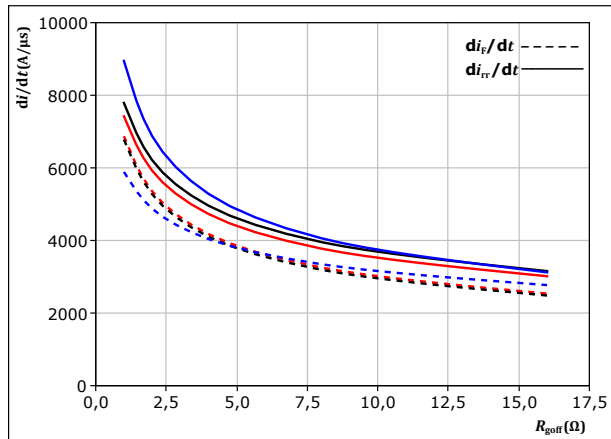
With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = 0/15 \text{ V}$   
 $R_{g(on)} = 4 \text{ } \Omega$

$T_j:$  — 25 °C  
— 125 °C  
— 150 °C

**figure 26.** FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor  
 $di_f/dt, di_r/dt = f(R_{g(off)})$



With an inductive load at

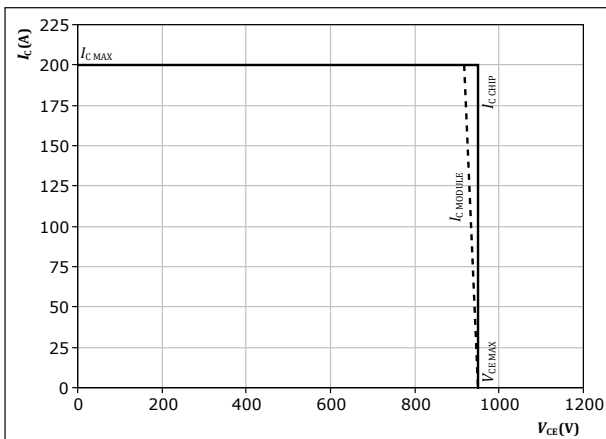
$V_{CE} = 600 \text{ V}$   
 $V_{GE} = 0/15 \text{ V}$   
 $I_C = 65 \text{ A}$

$T_j:$  — 25 °C  
— 125 °C  
— 150 °C

**figure 27.** IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$



At  $T_j = 150 \text{ } ^\circ\text{C}$   
 $R_{g(on)} = 4 \text{ } \Omega$   
 $R_{g(off)} = 4 \text{ } \Omega$

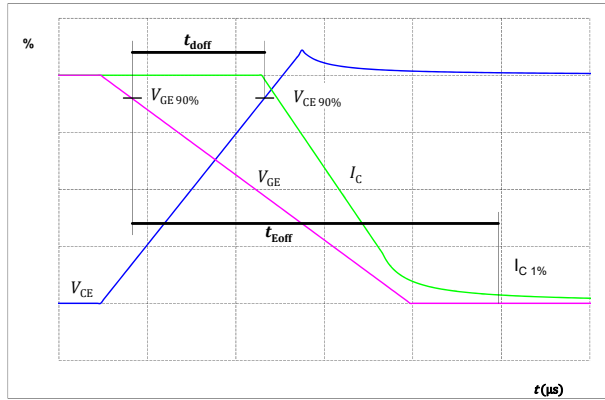


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## Boost Switching Definitions

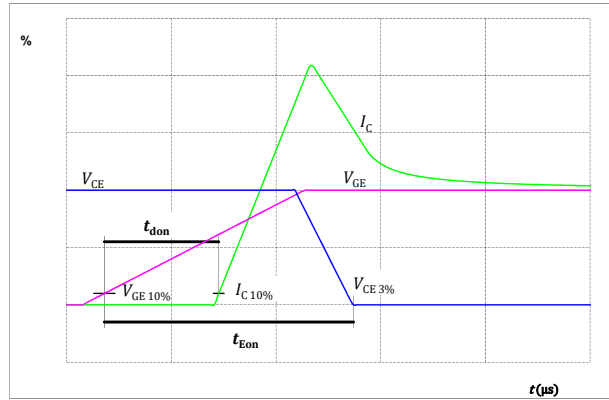
**figure 28.** IGBT

Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )



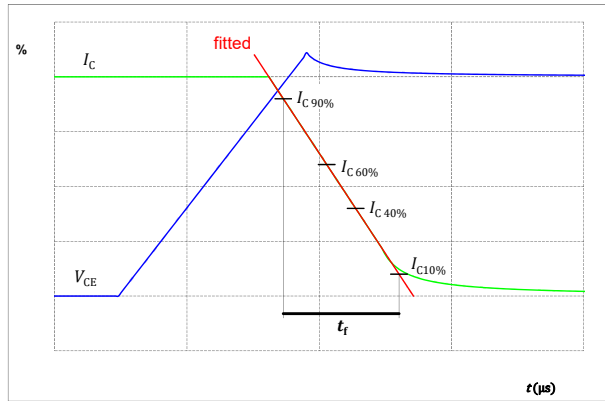
**figure 29.** IGBT

Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )



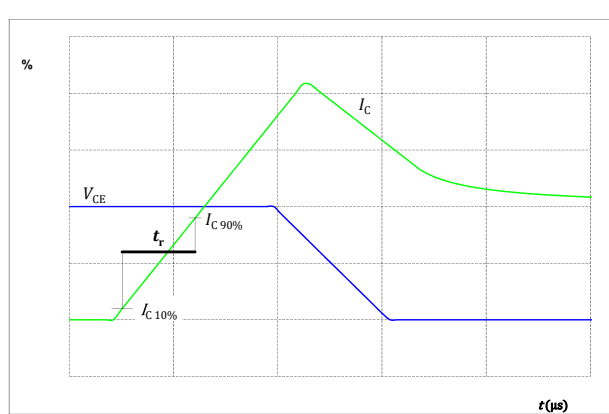
**figure 30.** IGBT

Turn-off Switching Waveforms & definition of  $t_f$



**figure 31.** IGBT

Turn-on Switching Waveforms & definition of  $t_r$





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## Boost Switching Definitions

figure 32.

FWD

Turn-off Switching Waveforms & definition of  $t_{rr}$

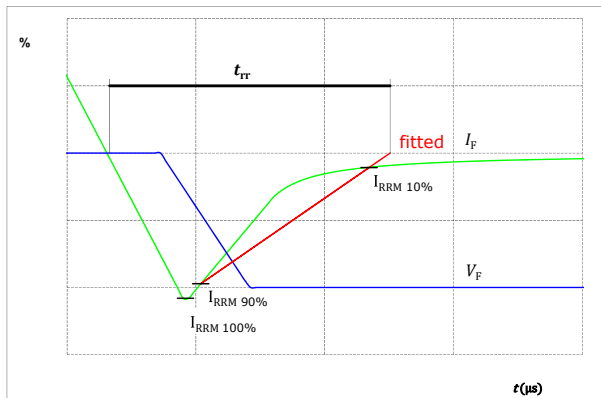
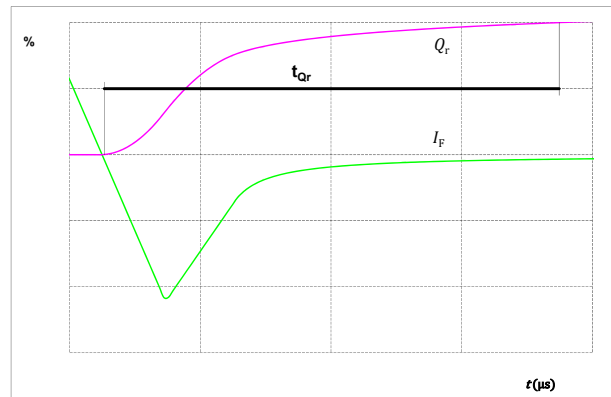


figure 33.

FWD


Turn-on Switching Waveforms & definition of  $t_{Qr}$  ( $t_{Qr}$  = integrating time for  $Q_r$ )





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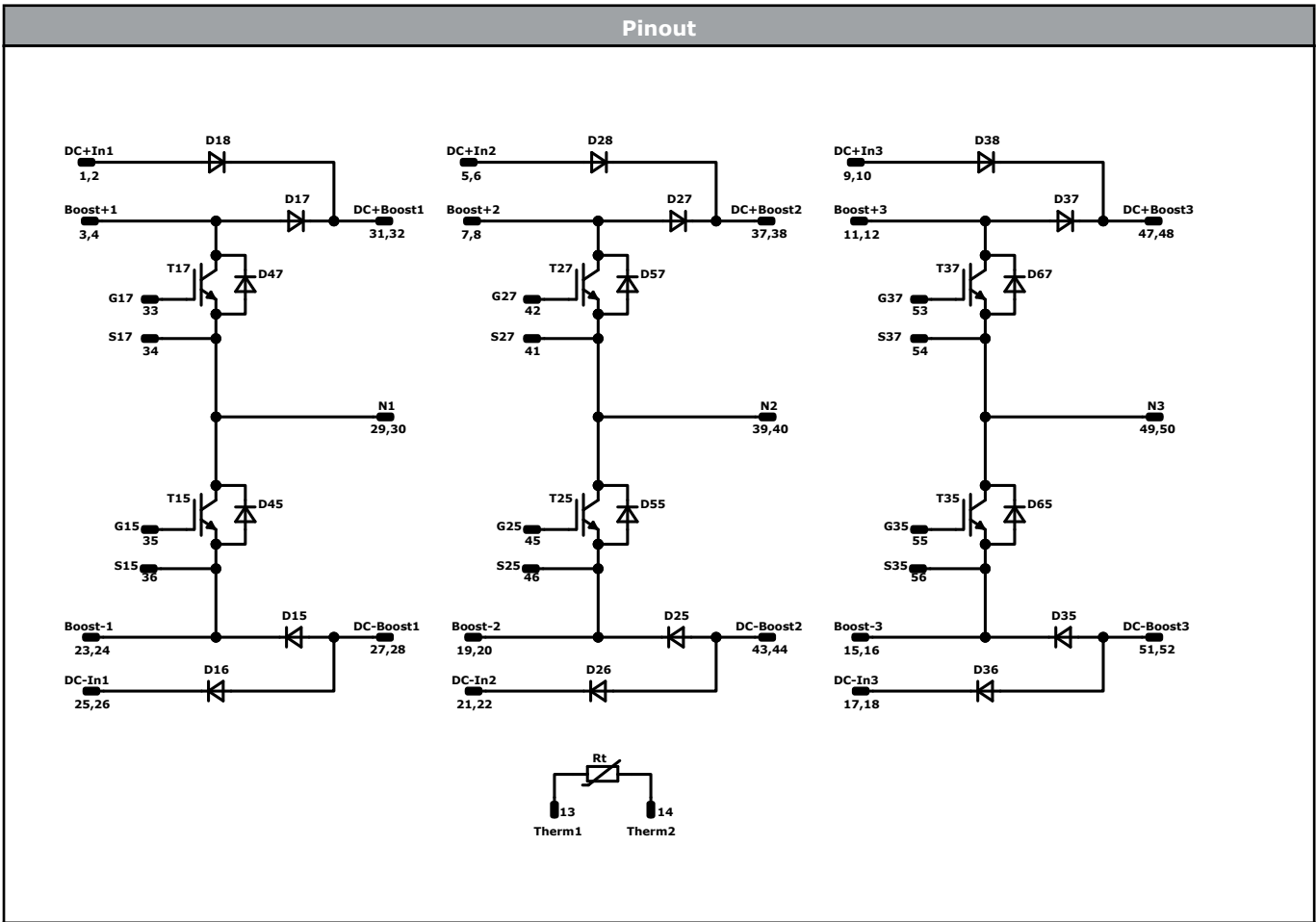
Ordering Code	
Version	Ordering Code
With thermal paste (4.4 W/mK, PTM6000)	B0-SP10S3A100S710-LR69L03T-/7/

Marking							
	Text	Name NN-NNNNNNNNNNNNNN- TTTTTV		Date code WWYY	UL & VIN UL VIN	Lot LLLLL	Serial SSSS
		Datamatrix	Type&Ver TTTTTV	Lot number LLLL	Serial SSSS	Date code WWYY	

Outline							
Pin table [mm]							
Pin	X	Y	Function	29	26,2	50,4	N1
1	52,4	50,4	DC+In1	30	28,9	50,4	N1
2	52,4	47,7	DC+In1	31	38,6	50,4	DC+Boost1
3	52,4	41,7	Boost+1	32	41,3	50,4	DC+Boost1
4	52,4	39	Boost+1	33	31,4	43,9	G17
5	52,4	32,6	DC+In2	34	28,4	43,9	S17
6	52,4	29,9	DC+In2	35	14,2	42,3	G15
7	52,4	23,9	Boost+2	36	11,8	39,3	S15
8	52,4	21,2	Boost+2	37	41,3	32,6	DC+Boost2
9	52,4	14,8	DC+In3	38	38,6	32,6	DC+Boost2
10	52,4	12,1	DC+In3	39	26,9	34,6	N2
11	52,4	6,1	Boost+3	40	26,9	31,9	N2
12	52,4	3,4	Boost+3	41	28,9	28,9	S27
13	24,35	0	Therm1	42	31,4	25,9	G27
14	21,35	0	Therm2	43	16,5	32,6	DC-Boost2
15	2,7	0	Boost-3	44	13,8	32,6	DC-Boost2
16	0	0	Boost-3	45	14,2	24,5	G25
17	0	6,05	DC-In3	46	11,8	21,5	S25
18	0	8,75	DC-In3	47	41,3	14,8	DC+Boost3
19	2,7	17,8	Boost-2	48	38,6	14,8	DC+Boost3
20	0	17,8	Boost-2	49	28,9	14,8	N3
21	0	23,85	DC-In2	50	26,2	14,8	N3
22	0	26,55	DC-In2	51	16,5	14,8	DC-Boost3
23	2,7	35,6	Boost-1	52	13,8	14,8	DC-Boost3
24	0	35,6	Boost-1	53	31,4	8,3	G37
25	0	41,65	DC-In1	54	28,4	8,3	S37
26	0	44,35	DC-In1	55	14,2	6,7	G35
27	13,8	50,4	DC+Boost1	56	11,8	3,7	S35
28	16,5	50,4	DC-Boost1				



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Identification					
ID	Component	Voltage	Current	Function	Comment
T15, T17, T25, T27, T35, T37	IGBT	950 V	100 A	Boost Switch	
D15, D17, D25, D27, D35, D37	FWD	1200 V	40 A	Boost Diode	
D45, D47, D57, D55 , D65, D67	Rectifier	1600 V	35 A	Boost Sw. Protection Diode	
D16, D18, D26, D28, D36, D38	Rectifier	1600 V	35 A	ByPass Diode	
Rt	Thermistor			Thermistor	



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Packaging instruction				
Standard packaging quantity (SPQ) 45	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for <i>flow</i> S3 packages see vincotech.com website.

Package data
Package data for <i>flow</i> S3 packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
B0-SP10S3A100S710-LR69L03T-D1-14	21 Jul. 2021		

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.